

Electronic Acknowledgement Receipt

EFS ID:	4356348
Application Number:	10823970
International Application Number:	
Confirmation Number:	5318
Title of Invention:	Semiconductor device having a pad metal layer and a lower metal layer that are electrically coupled, whereas apertures are formed in the lower metal layer below a center area of the pad metal layer
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Attorney Docket Number:	AMD-AFO1215
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Application Type:	Utility under 35 USC 111(a)

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Submitted with Payment	yes
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Payment was successfully received in RAM	\$810
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
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1	Request for Continued Examination (RCE)	AF01215_RCETrans.pdf	698444 502b486e7dce2af6b2a877454b2cd117f a872f	no	3
Warnings:					
Information:					
2	Amendment Submitted/Entered with Filing of CPA/RCE	AF01215_RCE.pdf	74158 8f4f46548b3c2af6a982b38b-cd992273 a88c9	no	12
Warnings:					
Information:					
3	Fee Worksheet (PTO-06)	fee-info.pdf	30414 e8e0901414210ee9f86a301b44d73435d84 52f0b	no	2
Warnings:					
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Total Files Size (in bytes):			803016		
<p>This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.</p> <p><u>New Applications Under 35 U.S.C. 111</u> If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.</p> <p><u>National Stage of an International Application under 35 U.S.C. 371</u> If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.</p> <p><u>New International Application Filed with the USPTO as a Receiving Office</u> If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.</p>					